

## LCD and Camera EMI Filter Array with ESD Protection

### Features

- Four, six and eight channels of EMI filtering with integrated ESD protection
- Pi-style EMI filters in a capacitor-resistor-capacitor (C-R-C) network
- $\pm 15\text{kV}$  ESD protection on each channel (IEC 61000-4-2 Level 4, contact discharge)
- $\pm 30\text{kV}$  ESD protection on each channel (HBM)
- Greater than 35dB attenuation (typical) at 1 GHz
- TDFN package with 0.40mm lead pitch:
  - 4-ch. = 8-lead TDFN
  - 6-ch. = 12-lead TDFN
  - 8-ch. = 16-lead TDFN
- Tiny TDFN package size:
  - 8-lead: 1.7mm x 1.35mm
  - 12-lead: 2.5mm x 1.35mm
  - 16-lead: 3.3mm x 1.35mm
- Increased robustness against vertical impacts during manufacturing process
- Lead-free finishing

### Applications

- LCD and Camera data lines in mobile handsets
- I/O port protection for mobile handsets, notebook computers, PDAs etc.
- EMI filtering for data ports in cell phones, PDAs or notebook computers.
- Wireless handsets
- Handheld PCs/PDAs
- LCD and camera modules

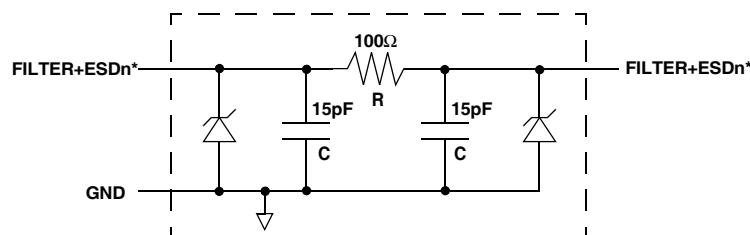
### Product Description

The CM1431 is a family of pi-style EMI filter arrays with ESD protection, which integrates four, six and eight filters (C-R-C) in small form factor TDFN 0.40mm pitch packages. The CM1431 has component values of 15pF-100 $\Omega$ -15pF per channel. The CM1431 has a cut-off frequency of 120MHz and can be used in applications with data rates up to 48Mbps. The parts include ESD diodes on every pin, which provide a very high level of protection for sensitive electronic components that may be subjected to electrostatic discharge (ESD). The ESD protection diodes safely dissipate ESD strikes of  $\pm 15\text{kV}$ , well beyond the maximum requirement of the IEC61000-4-2 international standard. Using the MIL-STD-883 (Method 3015) specification for Human Body Model (HBM) ESD, the pins are protected for contact discharges at greater than  $\pm 30\text{kV}$ .

These devices are particularly well-suited for portable electronics (e.g. wireless handsets, PDAs, notebook computers) because of their small package and easy-to-use pin assignments. In particular, the CM1431 is ideal for EMI filtering and protecting data and control lines for the I/O data ports, LCD display and camera interface in mobile handsets.

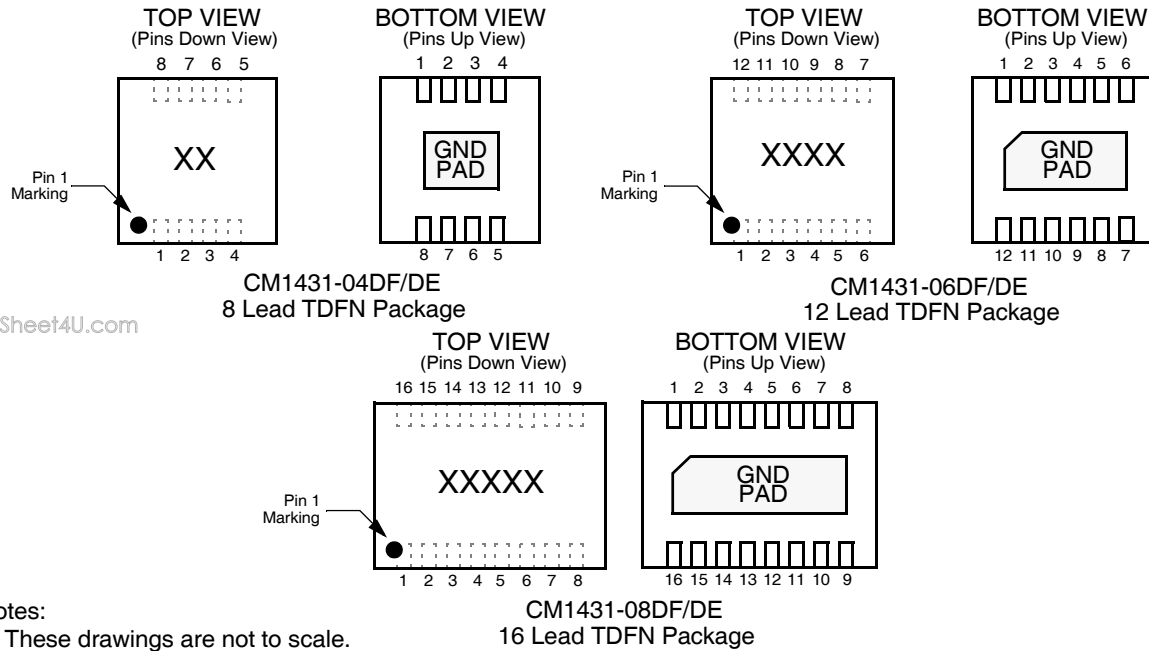
The CM1431 is housed in space-saving, low-profile 8-, 12- and 16-lead TDFN packages with a 0.40mm pitch and is available with lead-free finishing. This smaller size TDFN package provides up to 42% board space saving vs. the 0.50mm pitch TDFN packages.

### Electrical Schematic



\* See Package/Pinout Diagram for expanded pin information.

1 of 4, 6 or 8 EMI/RFI + ESD Channels

**PACKAGE / PINOUT DIAGRAMS**

**PIN DESCRIPTIONS**

DEVICE PIN(s)			NAME	DESCRIPTION	DEVICE PIN(s)			NAME	DESCRIPTION
-04	-06	-08			-04	-06	-08		
1	1	1	FILTER1	Filter + ESD Channel 1	8	12	16	FILTER1	Filter + ESD Channel 1
2	2	2	FILTER2	Filter + ESD Channel 2	7	11	15	FILTER2	Filter + ESD Channel 2
3	3	3	FILTER3	Filter + ESD Channel 3	6	10	14	FILTER3	Filter + ESD Channel 3
4	4	4	FILTER4	Filter + ESD Channel 4	5	9	13	FILTER4	Filter + ESD Channel 4
	5	5	FILTER5	Filter + ESD Channel 5		8	12	FILTER5	Filter + ESD Channel 5
	6	6	FILTER6	Filter + ESD Channel 6		7	11	FILTER6	Filter + ESD Channel 6
		7	FILTER7	Filter + ESD Channel 7			10	FILTER7	Filter + ESD Channel 7
		8	FILTER8	Filter + ESD Channel 8			9	FILTER8	Filter + ESD Channel 8
GND PAD			GND	Device Ground					

**Ordering Information**
**PART NUMBERING INFORMATION**

Pins	Package	Standard Finish		Lead-free Finish	
		Ordering Part Number <sup>1</sup>	Part Marking	Ordering Part Number <sup>1</sup>	Part Marking
8	TDFN-8	CM1431-04DF	WF	CM1431-04DE	WE
12	TDFN-12	CM1431-06DF	N31F	CM1431-06DE	N31E
16	TDFN-16	CM1431-08DF	N318F	CM1431-08DE	N318E

Note 1: Parts are shipped in Tape &amp; Reel form unless otherwise specified.

## Specifications

### ABSOLUTE MAXIMUM RATINGS

PARAMETER	RATING	UNITS
Storage Temperature Range	-65 to +150	°C
DC Power per Resistor	100	mW
DC Package Power Rating	500	mW

### STANDARD OPERATING CONDITIONS

PARAMETER	RATING	UNITS
Operating Temperature Range	-40 to +85	°C

### ELECTRICAL OPERATING CHARACTERISTICS (SEE NOTE1)

SYMBOL	PARAMETER	CONDITIONS	MIN	TYP	MAX	UNITS
R	Resistance		80	100	120	Ω
C <sub>TOTAL</sub>	Total Channel Capacitance	At 2.5VDC Reverse Bias, 1MHz, 30mVAC	24	30	36	pF
C	Capacitance C	At 2.5VDC Reverse Bias, 1MHz, 30mVAC	12	15	18	pF
V <sub>DIODE</sub>	Standoff Voltage	I <sub>DIODE</sub> =10μA		6.0		V
I <sub>LEAK</sub>	Diode Leakage Current (reverse bias)	V <sub>DIODE</sub> =+3.3V		0.1	1.0	μA
V <sub>SIG</sub>	Signal Clamp Voltage Positive Clamp Negative Clamp	I <sub>LOAD</sub> = 10mA I <sub>LOAD</sub> = -10mA	5.6 -1.5	6.8 -0.8	9.0 -0.4	V V
V <sub>ESD</sub>	In-system ESD Withstand Voltage a) Human Body Model, MIL-STD-883, Method 3015 b) Contact Discharge per IEC 61000-4-2 Level 4	Notes 2 and 3	±30 ±15			kV kV
R <sub>DYN</sub>	Dynamic Resistance Positive Negative			2.3 0.9		Ω Ω
f <sub>C</sub>	Cut-off Frequency Z <sub>SOURCE</sub> =50Ω, Z <sub>LOAD</sub> =50Ω	Channel R = 100Ω, Channel C = 15pF		110		MHz
A <sub>1GHz</sub>	Absolute Attenuation @ 1GHz from 0dB Level	Z <sub>SOURCE</sub> = 50Ω, Z <sub>LOAD</sub> = 50Ω, DC Bias = 0V; Notes 1, 4 and 5		35		dB
A <sub>800MHz - 6GHz</sub>	Absolute Attenuation @ 800MHz to 6GHz from 0dB Level	Z <sub>SOURCE</sub> = 50Ω, Z <sub>LOAD</sub> = 50Ω, DC Bias = 0V; Notes 1, 4 and 5		30		dB

Note 1: T<sub>A</sub>=25°C unless otherwise specified.

Note 2: ESD applied to input and output pins with respect to GND, one at a time.

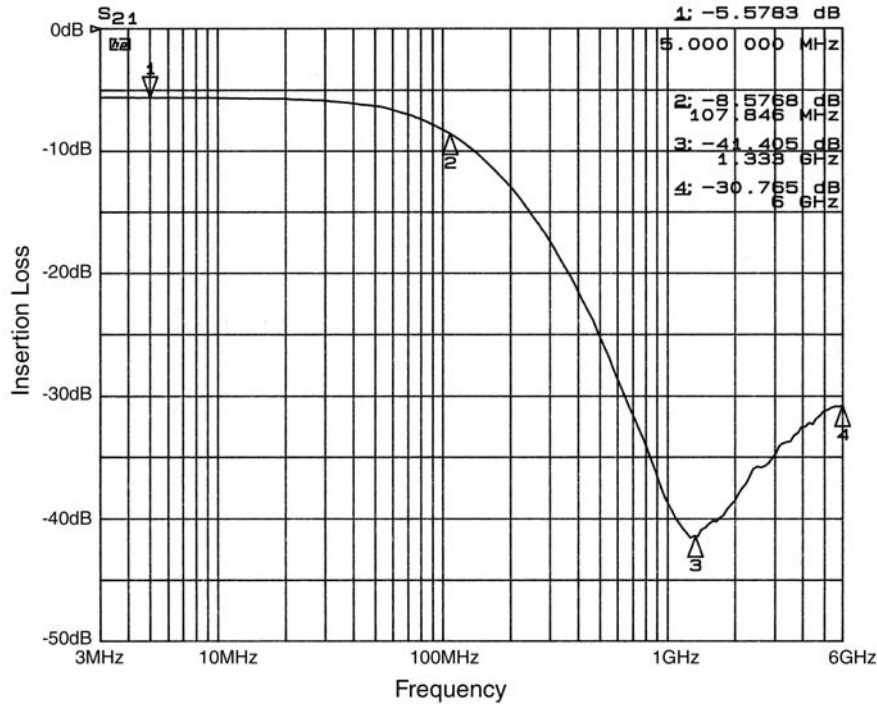
Note 3: These parameters are guaranteed by design and characterization.

Note 4: Attenuation / RF curves characterized by a network analyzer using microprobes.

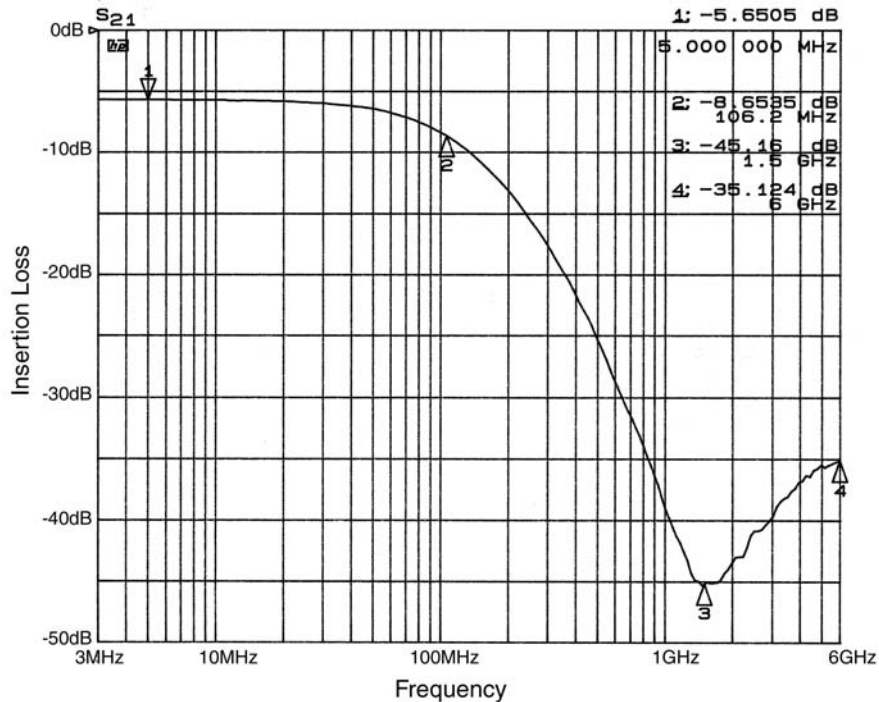
Note 5: These parameters are NOT guaranteed by design, characterization and production.

**Performance Information**

Typical Filter Performance (T<sub>A</sub>=25°C, DC Bias=0V, 50 Ohm Environment)



**Figure 1. Insertion Loss vs. Frequency (FILTER1 Input to GND)**



**Figure 2. Insertion Loss vs. Frequency (FILTER2 Input to GND)**

### Performance Information (cont'd)

Typical Filter Performance ( $T_A=25^\circ\text{C}$ , DC Bias=0V, 50 Ohm Environment)

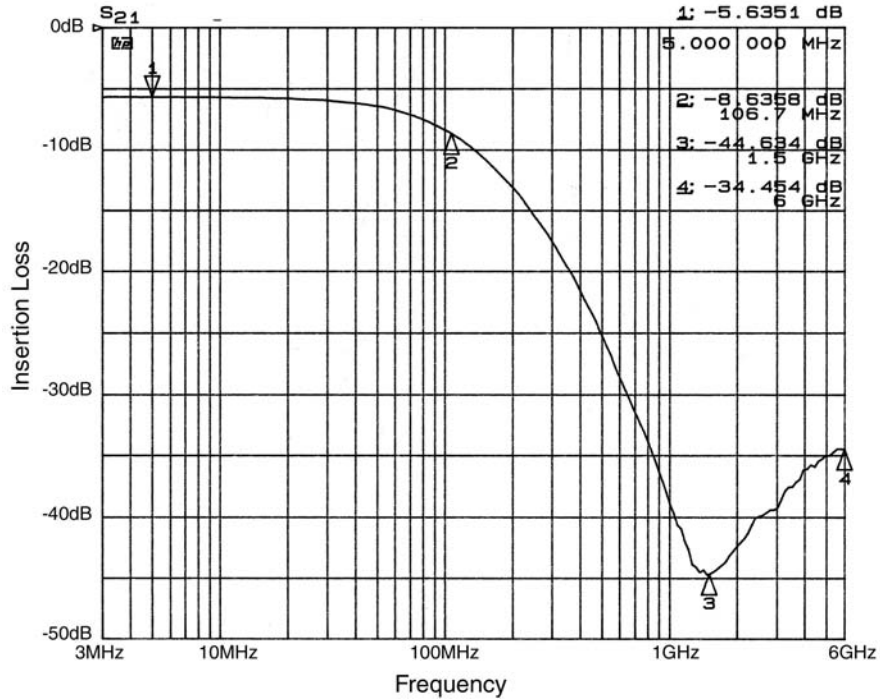


Figure 3. Insertion Loss vs. Frequency (FILTER3 Input to GND)

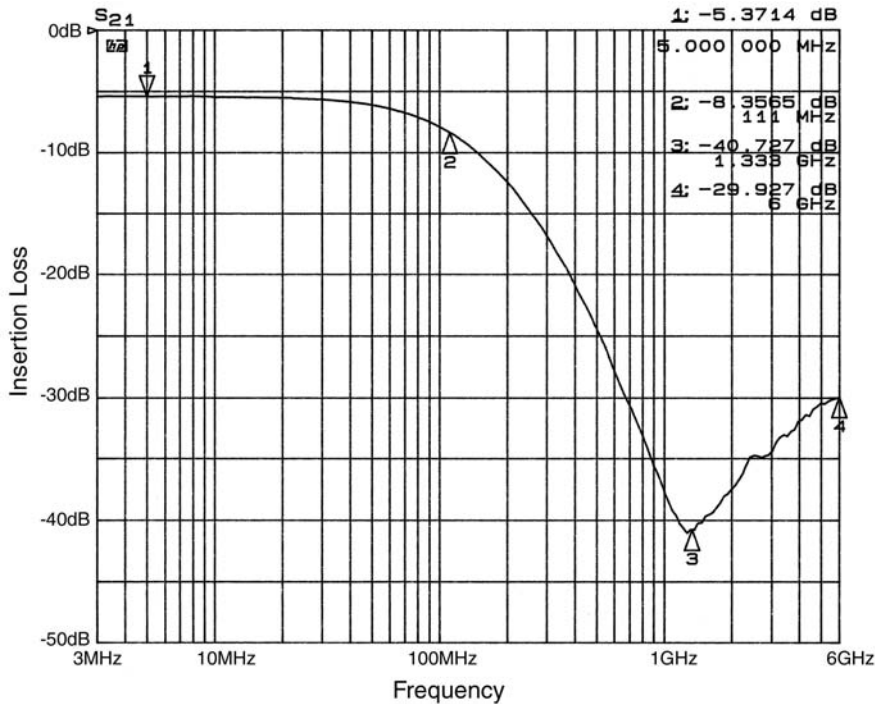
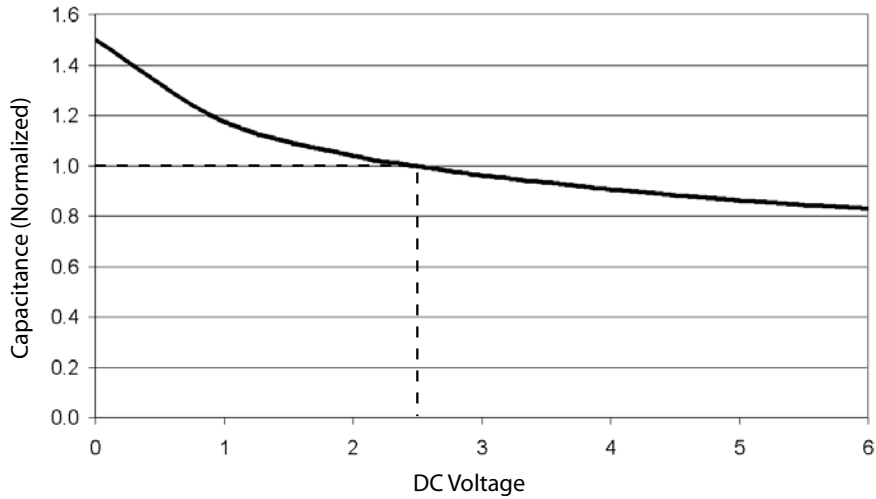


Figure 4. Insertion Loss vs. Frequency (FILTER4 Input to GND)

**Performance Information (cont'd)**

**Typical Diode Capacitance vs. Input Voltage**



**Figure 5. Filter Capacitance vs. Input Voltage (normalized to capacitance at 2.5VDC and 25°C)**

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## Mechanical Details

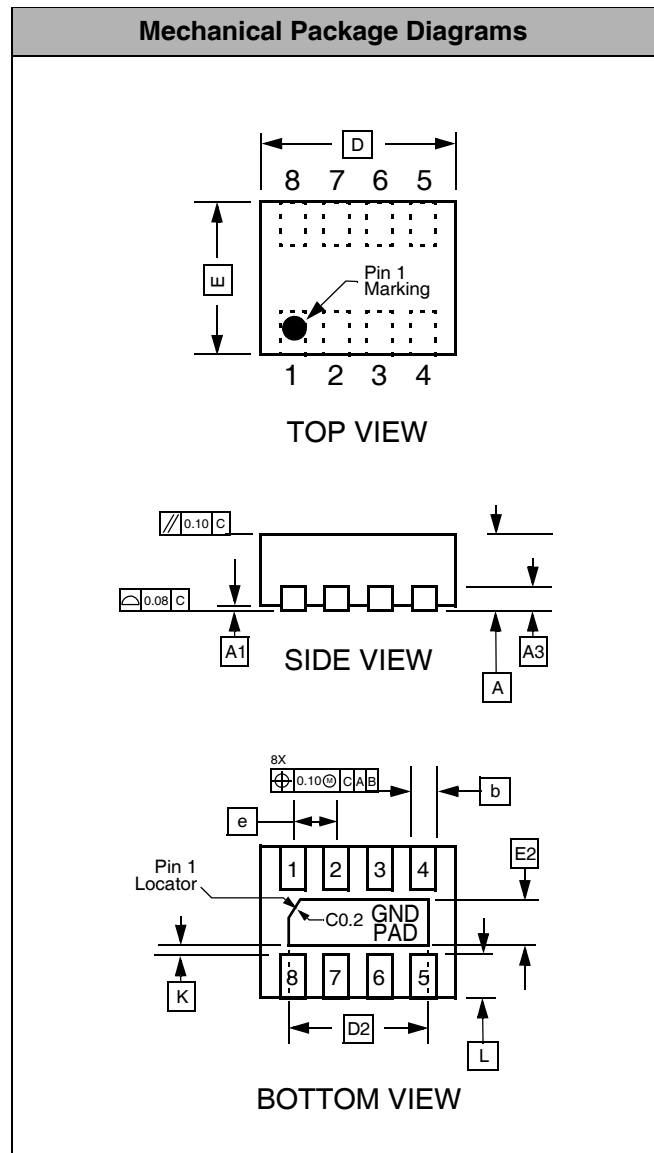
### CM1431-04DF/DE Mechanical Specifications

Dimensions for the CM1431-04DF/DE supplied in a 8-lead, 0.4mm pitch TDFN package are presented below.

For complete information on the TDFN-8, see the California Micro Devices TDFN Package Information document.

PACKAGE DIMENSIONS						
Package	TDFN					
JEDEC No.	MO-229C <sup>†</sup>					
Leads	8					
Dim.	Millimeters			Inches		
	Min	Nom	Max	Min	Nom	Max
A	0.70	0.75	0.80	0.028	0.030	0.031
A1	0.00	0.02	0.05	0.000	0.001	0.002
A3	0.20 REF			0.008 REF		
b	0.15	0.20	0.25	0.006	0.008	0.010
D	1.65	1.70	1.75	0.065	0.067	0.069
D2	1.10	1.20	1.30	0.043	0.047	0.051
E	1.30	1.35	1.40	0.051	0.053	0.055
E2	0.30	0.40	0.50	0.012	0.016	0.020
e	0.40 BSC			0.016 BSC		
K	0.20			0.008		
L	0.15	0.25	0.35	0.006	0.010	0.014
# per tape and reel	3000 pieces					
Controlling dimension: millimeters						

<sup>†</sup>This package is compliant with JEDEC standard MO-229C with the exception of the "D", "D2", "E", "E2", "K" and "L" dimensions as called out in the table above.



**Dimensions for 8-Lead, 0.4mm pitch TDFN package**

### Mechanical Details (cont'd)

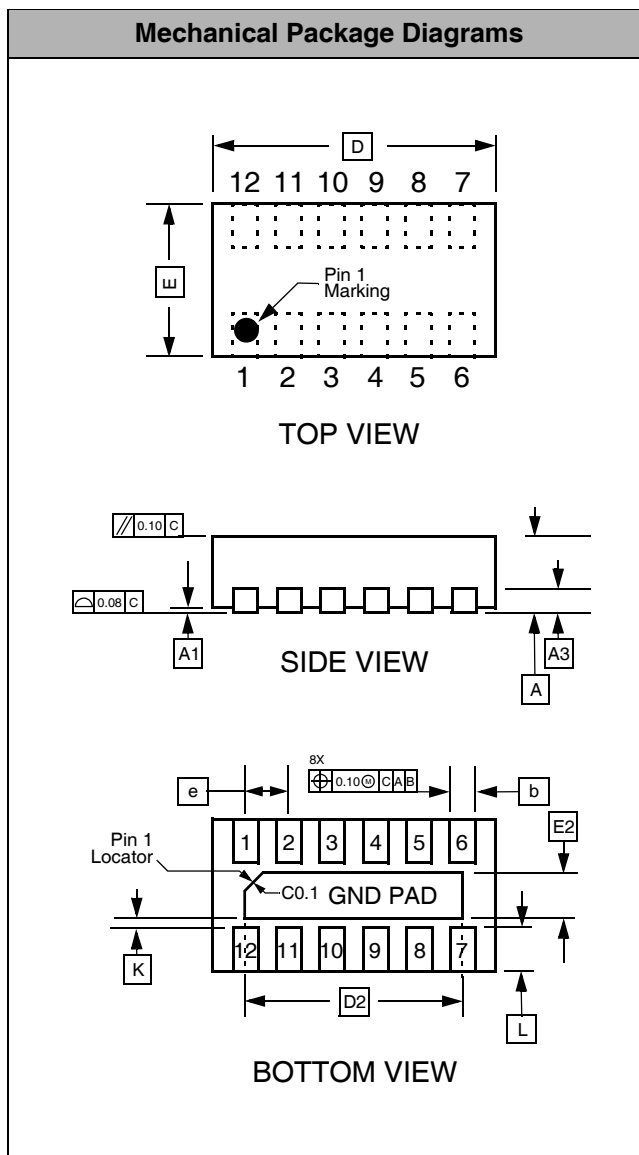
#### CM1431-06DF/DE Mechanical Specifications

Dimensions for the CM1431-06DF/DE supplied in a 12-lead, 0.4mm pitch TDFN package are presented below.

For complete information on the TDFN-12, see the California Micro Devices TDFN Package Information document.

PACKAGE DIMENSIONS						
Package	TDFN					
JEDEC No.	MO-229C <sup>†</sup>					
Leads	12					
Dim.	Millimeters			Inches		
	Min	Nom	Max	Min	Nom	Max
A	0.70	0.75	0.80	0.028	0.030	0.031
A1	0.00	0.02	0.05	0.000	0.001	0.002
A3	0.20 REF			0.008 REF		
b	0.15	0.20	0.25	0.006	0.008	0.010
D	2.45	2.50	2.55	0.096	0.098	0.100
D2	1.90	2.00	2.10	0.075	0.079	0.083
E	1.30	1.35	1.40	0.051	0.053	0.055
E2	0.25	0.35	0.45	0.010	0.014	0.018
e	0.40 BSC			0.016 BSC		
K	0.20			0.008		
L	0.15	0.25	0.35	0.006	0.010	0.014
# per tape and reel	3000 pieces					
Controlling dimension: millimeters						

<sup>†</sup>This package is compliant with JEDEC standard MO-229C with the exception of the "D", "D2", "E", "E2", "K" and "L" dimensions as called out in the table above.



Dimensions for 12-Lead, 0.4mm pitch TDFN package



## Mechanical Details (cont'd)

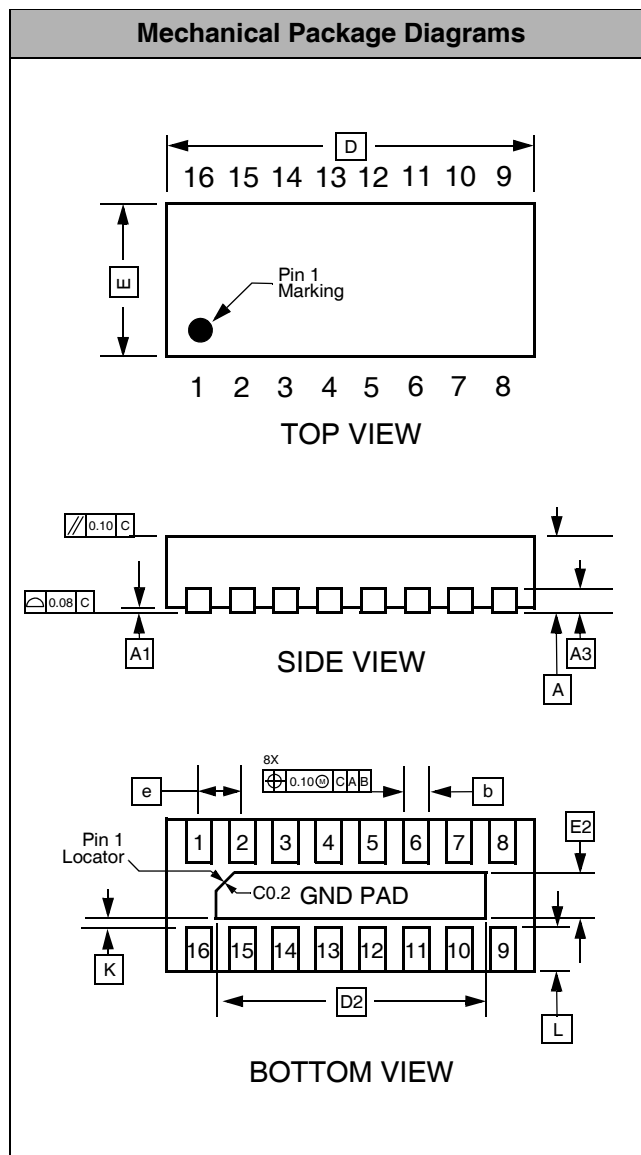
### CM1431-08DF/DE Mechanical Specifications

Dimensions for the CM1431-08DF/DE supplied in a 16-lead, 0.4mm pitch TDFN package are presented below.

For complete information on the TDFN-16, see the California Micro Devices TDFN Package Information document.

PACKAGE DIMENSIONS						
Package	TDFN					
JEDEC No.	MO-229C <sup>†</sup>					
Leads	16					
Dim.	Millimeters			Inches		
	Min	Nom	Max	Min	Nom	Max
A	0.70	0.75	0.80	0.028	0.030	0.031
A1	0.00	0.02	0.05	0.000	0.001	0.002
A3	0.40	0.55	0.70	0.016	0.022	0.028
b	0.20 REF			0.008 REF		
D	3.25	3.30	3.35	0.128	0.130	0.132
D2	2.80	2.90	3.00	0.110	0.114	0.118
E	1.30	1.35	1.40	0.051	0.053	0.055
E2	0.35	0.40	0.45	0.014	0.016	0.018
e	0.40 BSC			0.016 BSC		
K	0.20			0.008		
L	0.15	0.25	0.35	0.006	0.010	0.014
# per tape and reel	3000 pieces					
Controlling dimension: millimeters						

<sup>†</sup>This package is compliant with JEDEC standard MO-229C with the exception of the "D", "D2", "E", "E2", "K" and "L" dimensions as called out in the table above.



**Dimensions for 16-Lead, 0.4mm pitch TDFN package**